MU1014V LDMOS TRANSISTOR

MU1014V

140W, 50V High Power RF LDMOS FETs

Description

The MU1014V is a 140-watt, highly rugged, unmatched LDMOS FET, designed for wide-band commercial and industrial applications at frequencies HF to 1GHz.

•Typical Performance (On Innogration narrow band fixture with device soldered): $V_{DD} = 50$ Volts, $I_{DQ} = 100$ mA, CW.

| Frequency | Gp (dB) | P _{out} (W) | η _D @P _{out} (%) |
|-----------|---------|----------------------|--------------------------------------|
| 915 MHz | 20.5 | 140 | 62 |

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

Suitable Applications

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant
- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz 1000MHz (ISM, instrumentation)

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------------|------|
| DrainSource Voltage | V _{DSS} | 120 | Vdc |
| GateSource Voltage | V _{gs} | -10 to +10 | Vdc |
| Operating Voltage | V _{dd} | +55 | Vdc |
| Storage Temperature Range | Tstg | -65 to +150 | °C |
| Case Operating Temperature | T _c | +150 | °C |
| Operating Junction Temperature | ۲J | +225 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|--------|-------|------|
| Thermal Resistance, Junction to Case $T_c= 85^{\circ}C$, Pout=140W | Rejc | 0.95 | °C/W |

Table 3. ESD Protection Characteristics

| Test Methodology | Class | |
|------------------------------------|---------|--|
| Human Body Model (per JESD22—A114) | Class 2 | |



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| Table 4. Electrical Characteristics (TA = 25 °C unless otherwise noted) | | | | | |
|---|----------------------------------|----------------|--------------|---------------|------------|
| Characteristic | Symbol | Min | Тур | Max | Unit |
| DC Characteristics | | | | | |
| Drain-Source Voltage | N/ | | 122 | | V |
| V_{GS} =0, I_{DS} =1.0Ma | V _{(BR)DSS} | | 122 | | v |
| Zero Gate Voltage Drain Leakage Current | | | | 1 | μΑ |
| $(V_{DS} = 50V, V_{GS} = 0 V)$ | I _{DSS} | | | | |
| Gate—Source Leakage Current | | | | 4 | ٨ |
| $(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$ | I _{GSS} | | | 1 | μΑ |
| Gate Threshold Voltage | | | 2.56 | | V |
| $(V_{DS} = 50V, I_D = 600 \ \mu A)$ | V _{GS} (th) | | 2.56 | | V |
| Gate Quiescent Voltage | N | | 3.3 | | V |
| (V_{DD} = 50 V, I_{D} = 100 mA, Measured in Functional Test) | $V_{GS(Q)}$ | | | | |
| Drain source on state resistance | Rds(on) | | 208 | | mΩ |
| $(V_{DS} = 0.1V, V_{GS} = 10 V)$ | Rus(01) | | | | |
| Common Source Input Capacitance | C _{ISS} | | 110 | | pF |
| $(V_{GS} = 0V, V_{DS} = 50 V, f = 1 MHz)$ | | | | | |
| Common Source Output Capacitance | C _{oss} | | 42.4 | | pF |
| $(V_{GS} = 0V, V_{DS} = 50 V, f = 1 MHz)$ | | | | | |
| Common Source Feedback Capacitance | C _{RSS} | | 1.22 | | pF |
| $(V_{GS} = 0V, V_{DS} = 50 V, f = 1 MHz)$ | | | | | |
| Functional Tests (In Demo Test Fixture, 50 ohm system) V_{DD} = 5 | 50 Vdc, I _{DQ} = 100mA, | f = 915 MHz, 0 | CW Signal Me | asurements, P | in=30.9dBm |
| Power Gain@Pout | Gp | | 20.5 | | dB |
| Output Power | Pout | | 140 | | W |
| Drain Efficiency@Pout | η _D | | 62 | | % |
| Input Return Loss | IRL | | -7 | | dB |
| Ruggedness at all phase angle | VSWR | | 10:1 | | |

Package Outline

Flanged ceramic package; 2 leads

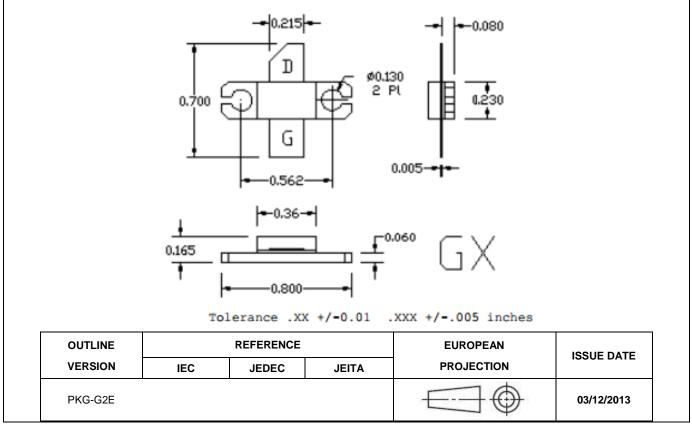


Figure 1. Package Outline PKG-G2E

Revision history

Table 5. Document revision history

| Date | Revision | Datasheet Status |
|-----------|----------|--------------------------------|
| 2017/7/18 | V1.0 | Preliminary Datasheet Creation |
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